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Rev.B Jan.-

/ Electrical Characteristic Curve

Fig. 1 - Static Characteristics

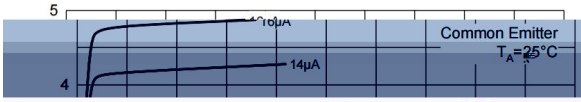
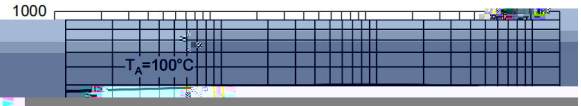
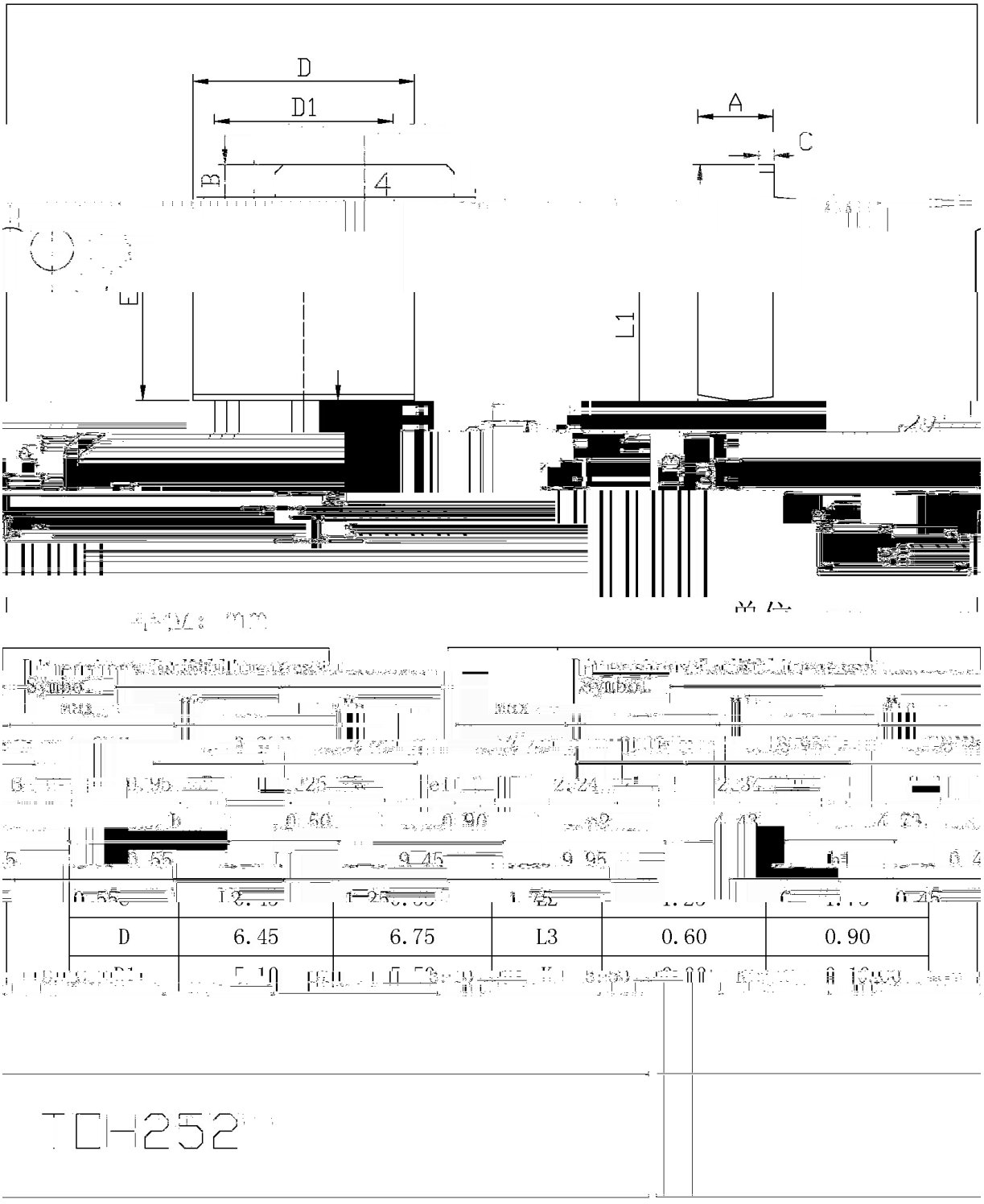


Fig. 2 - DC Current Gain Characteristics

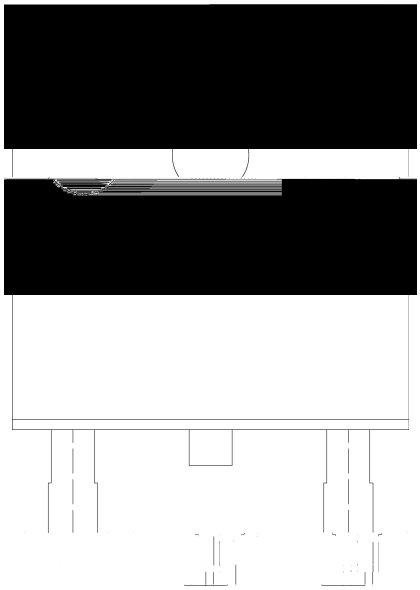


/ Package Dimensions

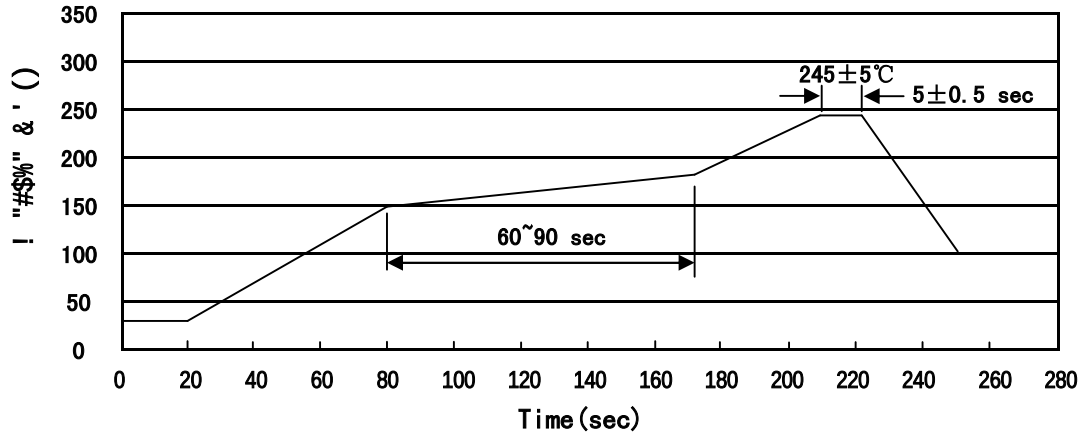


D	6.45	6.75	L3	0.60	0.90

/ Marking



( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



1	150	180	60	90sec;	Note: 1.Preheating:150~180℃, Time:60~90sec.
2	245±5			5±0.5sec;	2.Peak Temp.:245±5℃, Duration:5±0.5sec.
3			2	10℃/sec.	3. Cooling Speed: 2~10℃/sec.

/ Resistance to Soldering Heat Test Conditions

260±5℃	10±1 sec.	Temp.:260±5℃	Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension		(unit mm³)

/ TUBE

Package Type	Units					Dimension		(unit mm³)